

General Description

The UD3005 is the highest performance trench P-ch MOSFETs with extreme high cell density , which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The UD3005 meet the RoHS and Green Product requirement 100% EAS guaranteed with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

Absolute Maximum Ratings

| Symbol | Parameter | Rating | | Units |
|-----------------------|---|------------|--------------|-------|
| | | 10s | Steady State | |
| V_{DS} | Drain-Source Voltage | -30 | | V |
| V_{GS} | Gate-Source Voltage | ± 25 | | V |
| $I_D@T_C=25^\circ C$ | Continuous Drain Current, $V_{GS} @ -10V^1$ | -45 | | A |
| $I_D@T_C=100^\circ C$ | Continuous Drain Current, $V_{GS} @ -10V^1$ | -30 | | A |
| $I_D@T_A=25^\circ C$ | Continuous Drain Current, $V_{GS} @ -10V^1$ | -15 | -9.6 | A |
| $I_D@T_A=70^\circ C$ | Continuous Drain Current, $V_{GS} @ -10V^1$ | -12 | -7.7 | A |
| I_{DM} | Pulsed Drain Current ² | -150 | | A |
| EAS | Single Pulse Avalanche Energy ³ | 273 | | mJ |
| I_{AS} | Avalanche Current | -50 | | A |
| $P_D@T_C=25^\circ C$ | Total Power Dissipation ⁴ | 45 | | W |
| $P_D@T_A=25^\circ C$ | Total Power Dissipation ⁴ | 5 | 2.0 | W |
| T_{STG} | Storage Temperature Range | -55 to 150 | | °C |
| T_J | Operating Junction Temperature Range | -55 to 150 | | °C |

Thermal Data

| Symbol | Parameter | Typ. | Max. | Unit |
|-----------------|---|------|------|------|
| $R_{\theta JA}$ | Thermal Resistance Junction-Ambient ¹ | --- | 62 | °C/W |
| $R_{\theta JA}$ | Thermal Resistance Junction-Ambient ¹ ($t \leq 10s$) | --- | 25 | °C/W |
| $R_{\theta JC}$ | Thermal Resistance Junction-Case ¹ | --- | 2.8 | °C/W |

P-Ch 30V Fast Switching MOSFETs

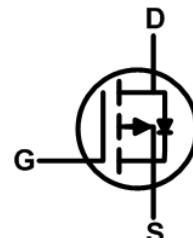
Product Summary

| BV_{DSS} | $R_{DS(ON)}$ | ID |
|------------|--------------|------|
| -30V | 15mΩ | -45A |

Applications

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

TO252 Pin Configuration



P-Ch 30V Fast Switching MOSFETs
Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|------------------------------|--|--|------|---------|-----------|----------------------------|
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{GS}=0\text{V}$, $I_D=-250\mu\text{A}$ | -30 | --- | --- | V |
| $\Delta BV_{DSS}/\Delta T_J$ | BVDSS Temperature Coefficient | Reference to 25°C , $I_D=-1\text{mA}$ | --- | -0.0232 | --- | $\text{V}/^\circ\text{C}$ |
| $R_{DS(\text{ON})}$ | Static Drain-Source On-Resistance ² | $V_{GS}=-10\text{V}$, $I_D=-30\text{A}$ | --- | 12 | 15 | $\text{m}\Omega$ |
| | | $V_{GS}=-4.5\text{V}$, $I_D=-15\text{A}$ | --- | 20 | 25 | |
| $V_{GS(\text{th})}$ | Gate Threshold Voltage | $V_{GS}=V_{DS}$, $I_D=-250\mu\text{A}$ | -1.0 | -1.5 | -2.5 | V |
| $\Delta V_{GS(\text{th})}$ | $V_{GS(\text{th})}$ Temperature Coefficient | | --- | 4.6 | --- | $\text{mV}/^\circ\text{C}$ |
| I_{DSS} | Drain-Source Leakage Current | $V_{DS}=-24\text{V}$, $V_{GS}=0\text{V}$, $T_J=25^\circ\text{C}$ | --- | --- | -1 | uA |
| | | $V_{DS}=-24\text{V}$, $V_{GS}=0\text{V}$, $T_J=55^\circ\text{C}$ | --- | --- | -5 | |
| I_{GSS} | Gate-Source Leakage Current | $V_{GS}=\pm 25\text{V}$, $V_{DS}=0\text{V}$ | --- | --- | ± 100 | nA |
| g_{fs} | Forward Transconductance | $V_{DS}=-5\text{V}$, $I_D=-30\text{A}$ | --- | 30 | --- | S |
| R_g | Gate Resistance | $V_{DS}=0\text{V}$, $V_{GS}=0\text{V}$, $f=1\text{MHz}$ | --- | 9 | 18 | Ω |
| Q_g | Total Gate Charge (-4.5V) | $V_{DS}=-15\text{V}$, $V_{GS}=-4.5\text{V}$, $I_D=-15\text{A}$ | --- | 22 | 30.8 | nC |
| Q_{gs} | Gate-Source Charge | | --- | 8.7 | 12.2 | |
| Q_{gd} | Gate-Drain Charge | | --- | 7.2 | 10 | |
| $T_{d(on)}$ | Turn-On Delay Time | $V_{DD}=-15\text{V}$, $V_{GS}=-10\text{V}$, $R_G=3.3\Omega$ | --- | 8 | 16 | ns |
| T_r | Rise Time | | --- | 73.7 | 132 | |
| $T_{d(off)}$ | Turn-Off Delay Time | | --- | 61.8 | 123 | |
| T_f | Fall Time | | --- | 24.4 | 48 | |
| C_{iss} | Input Capacitance | $V_{DS}=-15\text{V}$, $V_{GS}=0\text{V}$, $f=1\text{MHz}$ | --- | 2215 | 3100 | pF |
| C_{oss} | Output Capacitance | | --- | 310 | 434 | |
| C_{rss} | Reverse Transfer Capacitance | | --- | 237 | 330 | |

Guaranteed Avalanche Characteristics

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|--------|--|--|------|------|------|------|
| EAS | Single Pulse Avalanche Energy ⁵ | $V_{DD}=-25\text{V}$, $L=0.1\text{mH}$, $I_{AS}=-24\text{A}$ | 63 | --- | --- | mJ |

Diode Characteristics

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|----------|--|--|------|------|------|------|
| I_s | Continuous Source Current ^{1,6} | $V_G=V_D=0\text{V}$, Force Current | --- | --- | -45 | A |
| I_{SM} | Pulsed Source Current ^{2,6} | | --- | --- | -150 | A |
| V_{SD} | Diode Forward Voltage ² | $V_{GS}=0\text{V}$, $I_S=-1\text{A}$, $T_J=25^\circ\text{C}$ | --- | --- | -1 | V |
| t_{rr} | Reverse Recovery Time | $I_F=-15\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$, $T_J=25^\circ\text{C}$ | --- | 19 | --- | nS |
| Q_{rr} | Reverse Recovery Charge | | --- | 9 | --- | nC |

Note :

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$
- 3.The EAS data shows Max. rating . The test condition is $V_{DD}=-25\text{V}$, $V_{GS}=-10\text{V}$, $L=0.1\text{mH}$, $I_{AS}=-50\text{A}$
- 4.The power dissipation is limited by 150°C junction temperature
- 5.The Min. value is 100% EAS tested guarantee.
- 6.The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.

P-Ch 30V Fast Switching MOSFETs

Typical Characteristics

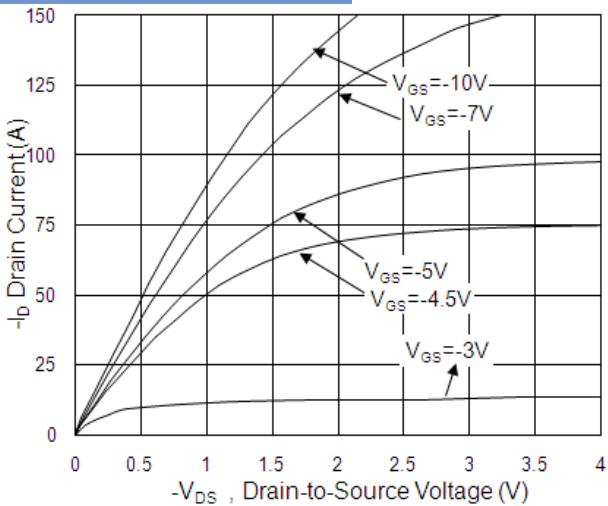


Fig.1 Typical Output Characteristics

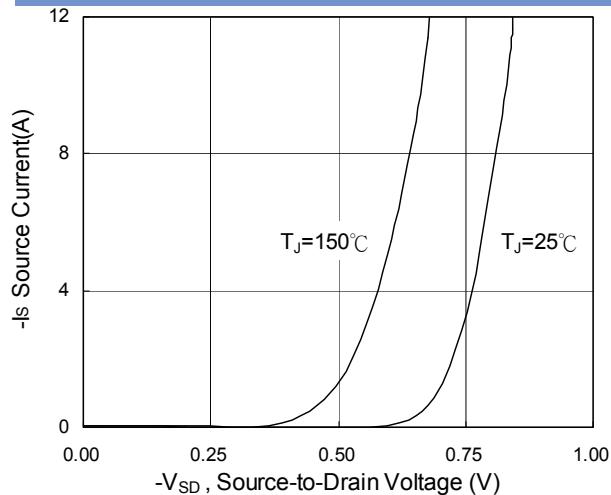


Fig.3 Forward Characteristics of Reverse

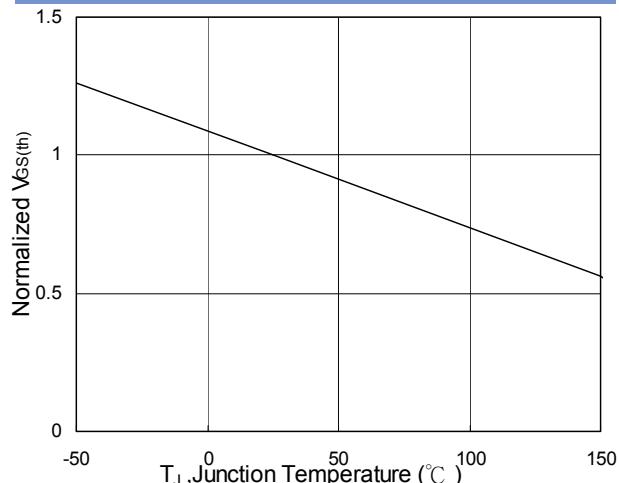


Fig.5 Normalized $V_{GS(th)}$ vs. T_J

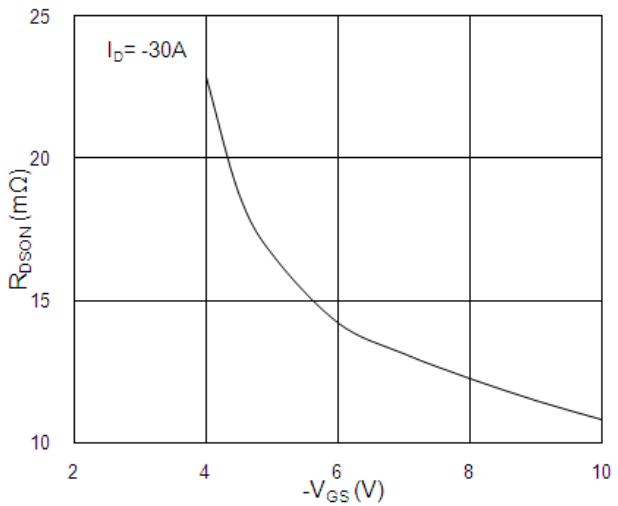


Fig.2 On-Resistance vs. G-S Voltage

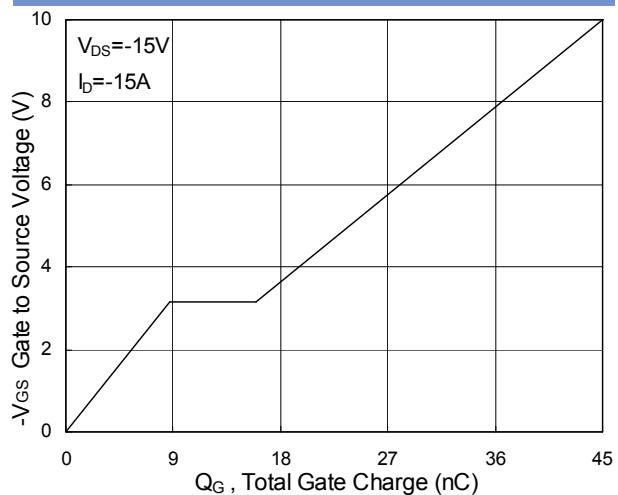


Fig.4 Gate-charge Characteristics

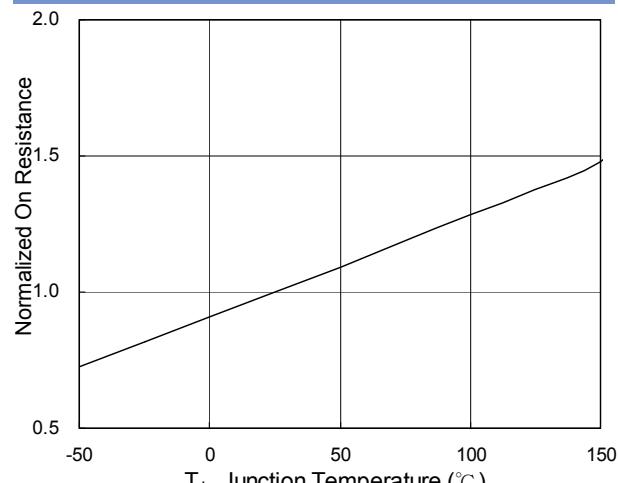


Fig.6 Normalized $R_{DS(on)}$ vs. T_J

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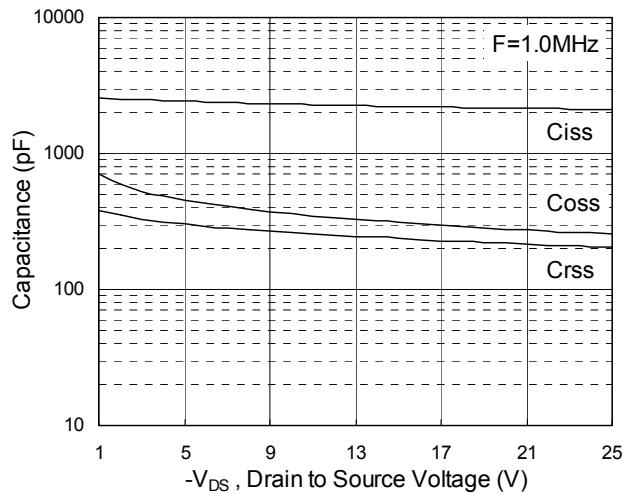


Fig.7 Capacitance

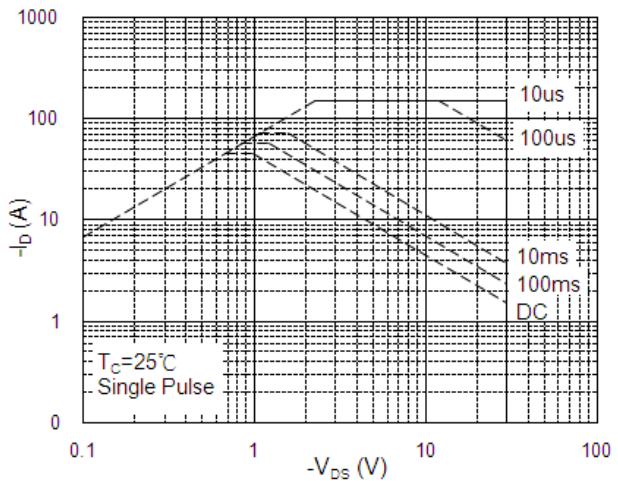


Fig.8 Safe Operating Area

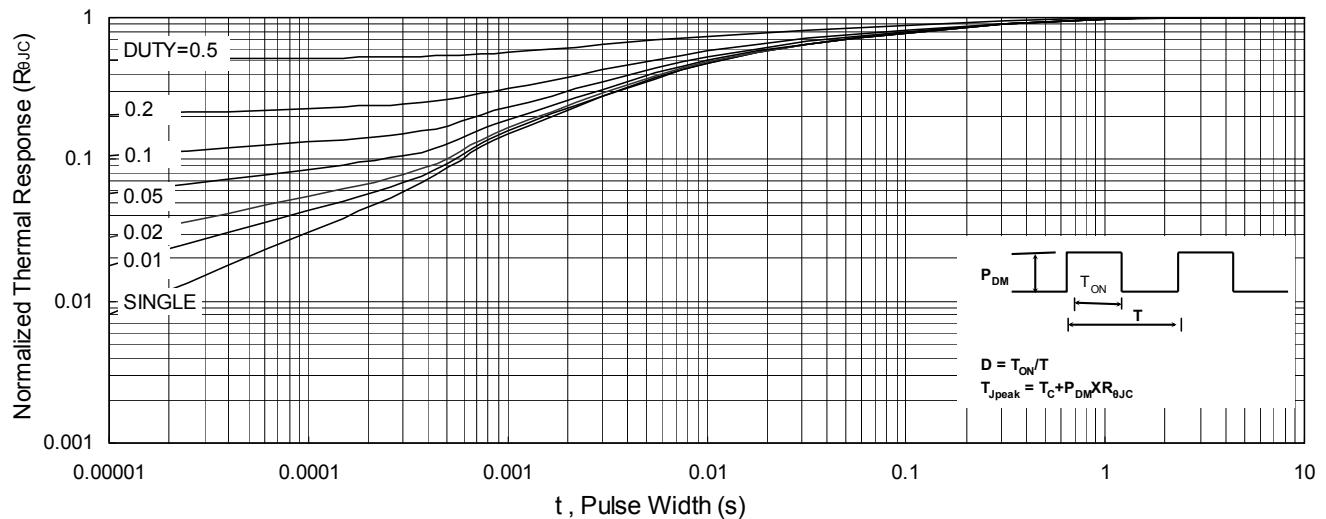


Fig.9 Normalized Maximum Transient Thermal Impedance

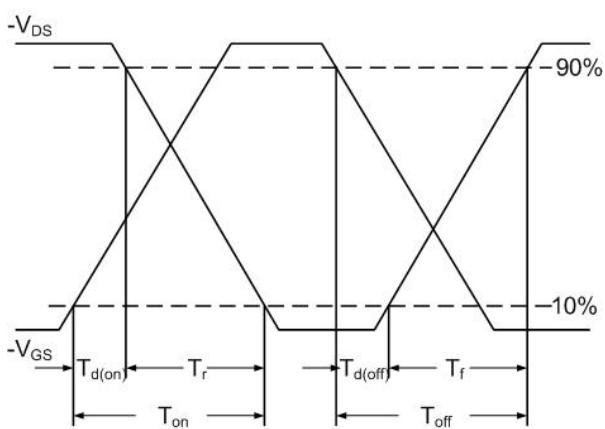


Fig.10 Switching Time Waveform

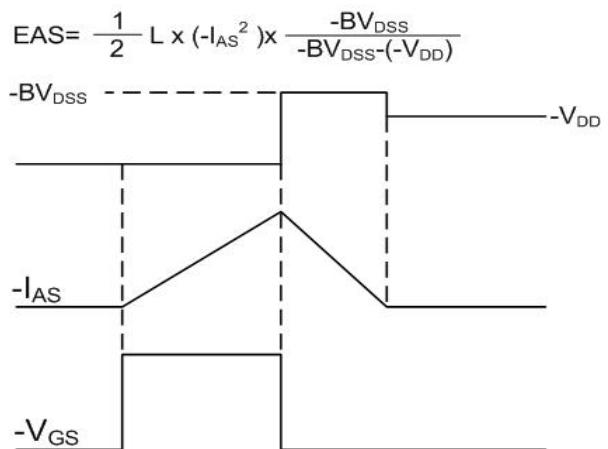


Fig.11 Unclamped Inductive Switching Waveform